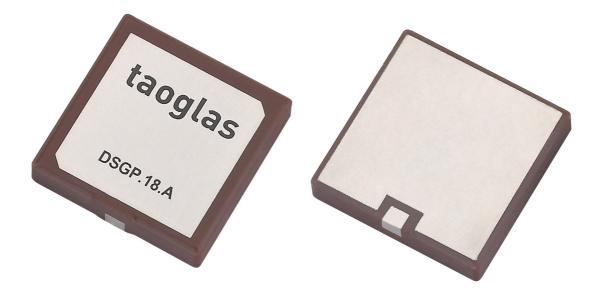


# **Specification**

- Part No. : **DSGP.1575.18.4.A.02**
- Description : GPS L1 / GALILEO E1 1575MHz SMT 18\*18\*4mm Ceramic Patch SMT Antenna
- Features : 4.20 dBi Peak Gain for GPS/GALILEO Band Dims: 18\*18\*4mm SMT Direct Mount Ceramic Patch Antenna Manufactured in an IATF16949 Approved Facility

#### **RoHS Compliant**





## **1. Introduction**

The DSGP.1575.18.4.A.02 is an 18mm square ceramic GPS L1 / GALILEO E1 passive patch antenna. 18mm square with a height of just 4mm, this low profile antenna is ideal for space constrained applications in telematics devices, vehicle tracking/fleet management systems, wearables and navigation.

The antenna has been tuned on a 50\*50mm ground plane, working at 1575.42MHz with a 4.20dBi gain. The radiation pattern is broadly hemispherical with a stable gain across elevations.

The ceramic patch is mounted via SMT process, ideal for high volume low cost assembly. It is manufactured and tested in a TS16949 first tier automotive approved facility.

For further optimization to customer specific device environments, custom tuned patch antennas can be supplied, subject to NRE and MOQ. For more details please contact your regional Taoglas sales office.



## 2. Specification

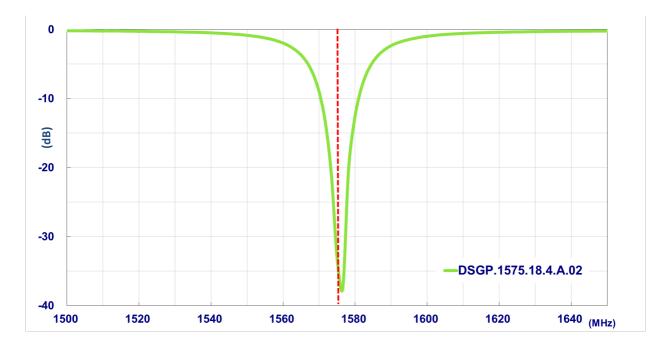
ELECTRICAL		
Application Bands	GPS/GALILEO	
Operation Frequency	1575.42 ±1.023MHz	
Return Loss	<-10dB	
Gain at Zenith	4.20dBi	
Efficiency	83.33%	
Impedance	50Ω	
MECHANICAL		
Ceramic Dimension	18*18*4mm	
Weight	5.8g	
ENVIRONMENTAL		
Operation Temperature	-40°C to 85°C	
Humidity	Non-condensing 65°C 95% RH	
Moisture Sensitivity Level (MSL)	3 (168 Hours)	

\*Antenna properties were measured with the antenna mounted on 50\*50mm Ground Plane Taoglas Part # DSGPD.18A

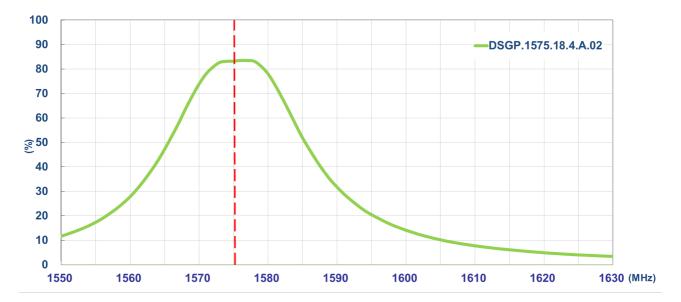


### 3. Antenna Characteristics

### 3.1. Return Loss

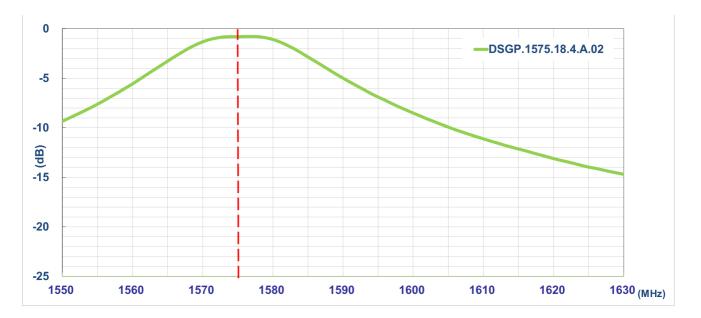


### 3.2. Efficiency





### 3.3. Average Gain



#### 3.4. Peak Gain



## 4. Antenna Radiation Pattern

### 4.1. Measurement Setup

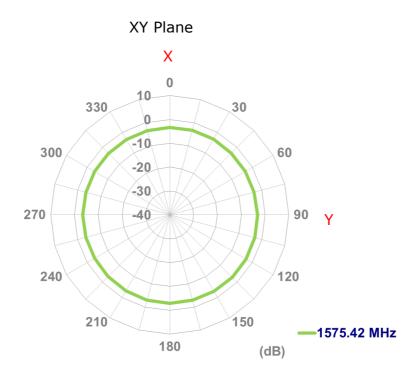
The DSGP.1575.18.4 antenna is tested with 50\*50mm ground plane in a CTIA certified

ETS-Lindgren Anechoic Chamber. The test setup is shown below.

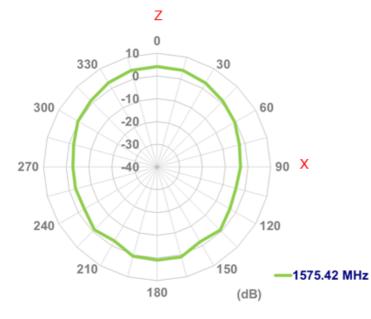




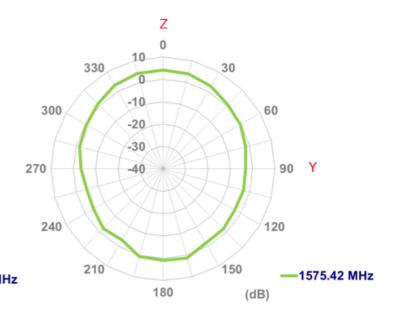
### 4.2. 2D Radiation Pattern



XZ Plane

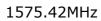


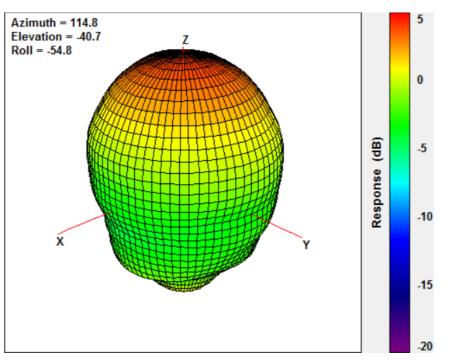
YZ Plane





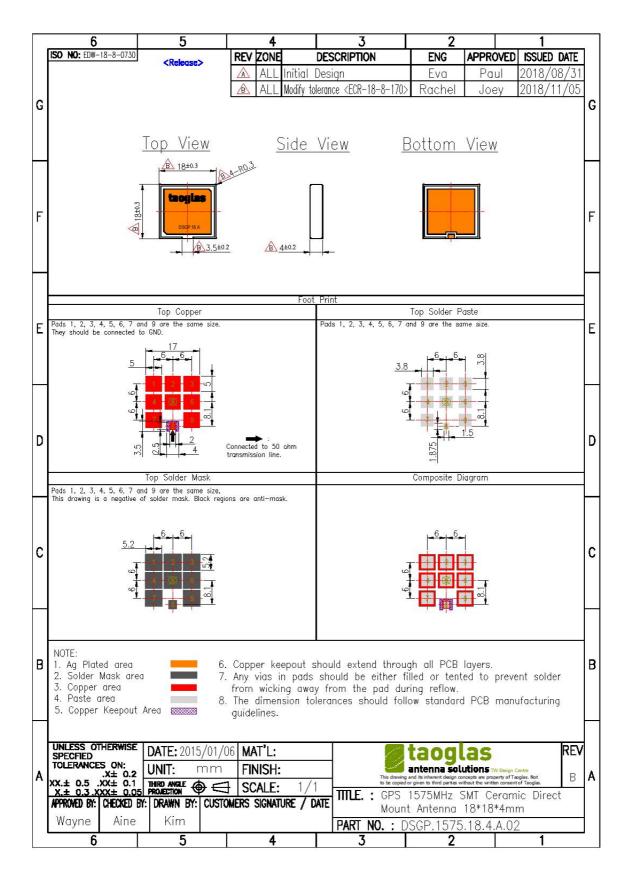
#### 4.3. 3D Radiation Pattern





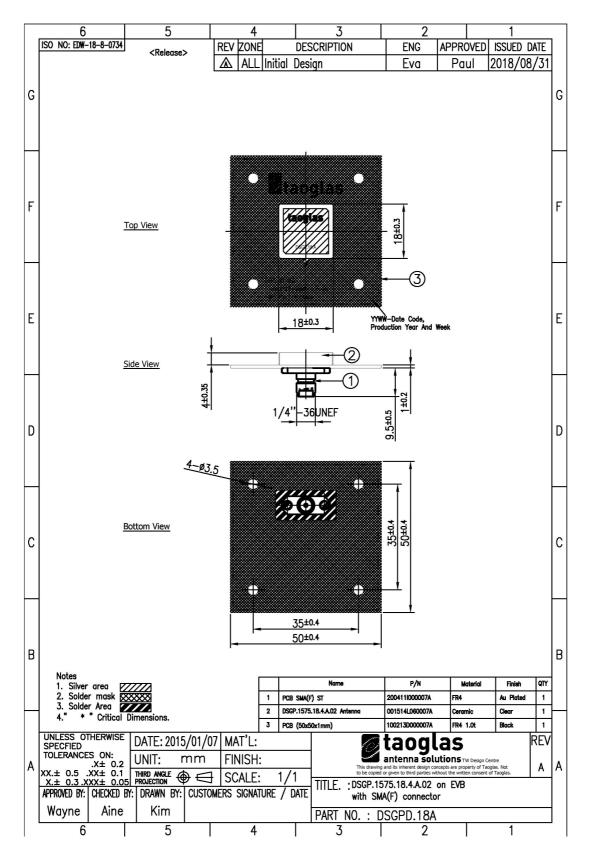


## 5. Mechanical Drawing (Unit: mm)





### 6. Evaluation Board - DSGPD.18A (Unit: mm)

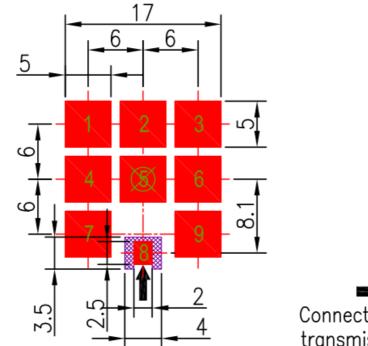




## **7. PCB Footprint Recommendation**

### 7.1. Footprint Copper Keepout Area (Unit: mm)

Pads 1, 2, 3, 4, 5, 6, 7 and 9 are the same size. They should be connected to GND



NOTE:

- 1. Ag Plated area
- Solder Mask area
- Copper area
- Paste area
- 5. Copper Keepout area 🛛 🗱
- 6. Copper Keepout should extend through all PCB layers.
- 7. Any vias in pads should be either filled or tented to prevent solder from wicking away from the pad during reflow

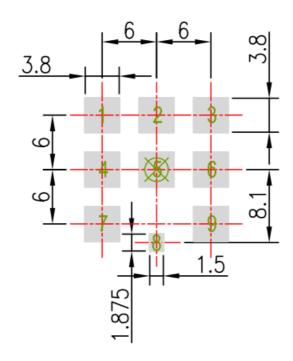
8. The dimension tolerances should follow standard PCB manufacturing guidelines

### 7.2. Paste Area (unit: mm)

Pads 1, 2, 3, 4, 5, 6, 7 and 9 are the same size.

Connected to 50 ohm transmission line.





#### NOTE:

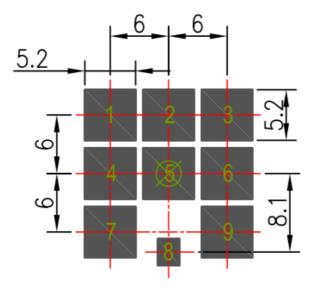
- 1. Ag Plated area
- 2. Solder Mask area
- 3. Copper area
- 4. Paste area
- 5. Copper Keepout area 🛛 🗱
- 6. Copper Keepout should extend through all PCB layers.
- 7. Any vias in pads should be either filled or tented to prevent solder from wicking away from the pad during reflow

8. The dimension tolerances should follow standard PCB manufacturing guidelines



#### 7.3. Top Solder Mask (Unit: mm)

Pads 1, 2, 3, 4, 5, 6, 7 and 9 are the same size. This drawing is a negative of solder mask. Black regions are anti-mask.



#### NOTE:

- 1. Ag Plated area
- 2. Solder Mask area



- Copper area
   Paste area
- 5. Copper Keepout area 🛛 🗱 🏧
- 6. Copper Keepout should extend through all PCB layers.

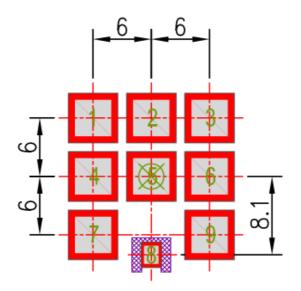
7. Any vias in pads should be either filled or tented to prevent solder

from wicking away from the pad during reflow

8. The dimension tolerances should follow standard PCB manufacturing guidelines



### 7.4. Composite Diagram (unit: mm)



#### NOTE:

- 1. Ag Plated area
- 2. Solder Mask area
- -----
- Copper area
   Paste area
- 5. Copper Keepout area 🛛 🗱
- 6. Copper Keepout should extend through all PCB layers.
- 7. Any vias in pads should be either filled or tented to prevent solder from wicking away from the pad during reflow

8. The dimension tolerances should follow standard PCB manufacturing guidelines



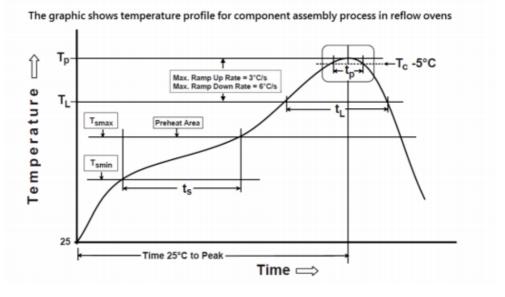
### 8. Recommended Reflow Soldering Profile

DSGP.18 can be assembled using lead-free process. According to the standard IPC/JEDEC J-STD-020C, the temperature profile suggested is as follows:

Phase	Profile Features	Pb-Free Assembly (SnAgCu)
PREHEAT	Temperature Min(Tsmin)	150°C
	Temperature Max(Tsmax)	200°C
	Time(ts) from (Tsmin to Tsmax)	60-120 seconds
RAMP-UP	Avg. Ramp-up Rate (Tsmax to TP)	3°C/second(max)
REFLOW	Temperature(TL)	217°C
	Total Time above TL (tL)	30-100 seconds
PEAK	Temperature(TP)	260°C
	Time(tp)	2-5 seconds
RAMP-DOWN	Rate	3°C/second(max)
Time from 25°C	C to Peak Temperature	8 minutes max.
Composition of	f solder paste	96.5Sn/3Ag/0.5Cu
Saldar Pasta Madal		SHENMAO DESOS DOS

Solder Paste Model

SHENMAO PF606-P26

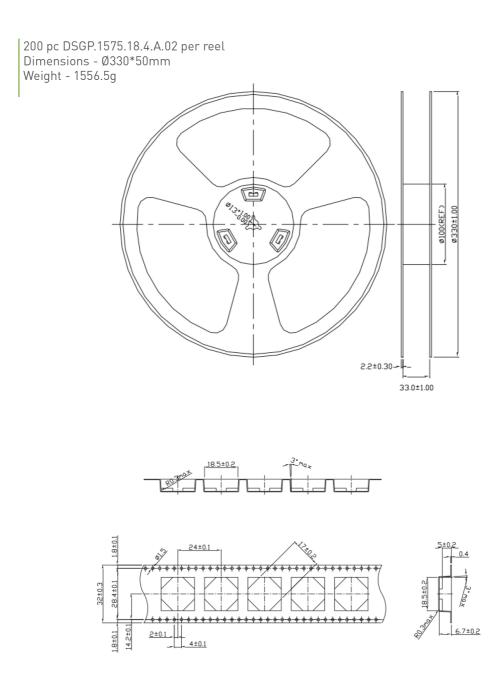


Soldering Iron condition: Soldering iron temperature 270°C±10°C. Apply preheating at 120°C for 2-3 minutes. Finish soldering for each terminal within 3 seconds, if soldering iron temperature over270°C±10°C or 3 seconds, it will make cause component surface peeling or damage.



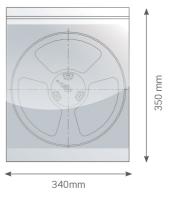
## 9. Packaging (Unit: mm)

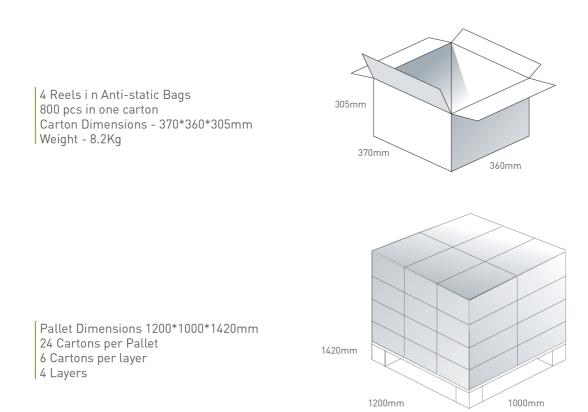
#### Packaging Specifications (1/2)





1 pc reel in small in Anti-static Bag Dimensions - 340\*350\*70mm Weight - 1.86Kg





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